## NLAS325

## Dual SPST Analog Switch, Low Voltage, Single Supply

The NLAS325 is a dual SPST (Single Pole, Single Throw) switch, similar to $1 / 2$ a standard 4066 . The device permits the independent selection of 2 analog/digital signals. Available in the Ultra-Small 8 package.

The use of advanced $0.6 \mu$ CMOS process, improves the $\mathrm{R}_{\mathrm{ON}}$ resistance considerably compared to older higher voltage technologies.

## Features

- On Resistance is $20 \Omega$ Typical at 5.0 V
- Matching is $<1.0 \Omega$ Between Sections
- 2.0-6.0 V Operating Range
- Ultra Low < 5.0 pC Charge Injection
- Ultra Low Leakage $<1.0 \mathrm{nA}$ at $5.0 \mathrm{~V}, 25^{\circ} \mathrm{C}$
- Wide Bandwidth > $200 \mathrm{MHz},-3.0 \mathrm{~dB}$
- 2000 V ESD (HBM)
- $\mathrm{R}_{\mathrm{ON}}$ Flatness $\pm 6.0 \Omega$ at 5.0 V
- Independent Enables; One Positive, One Negative
- These Devices are $\mathrm{Pb}-$ Free, Halogen Free/BFR Free and are RoHS Compliant


Figure 1. Pinout


ON Semiconductor ${ }^{\circledR}$
www.onsemi.com

(Note: Microdot may be in either location)

| PIN ASSIGNMENT |  |  |
| :---: | :---: | :---: |
| N | NO1 |  |
| 2 C | COM1 |  |
| 3 IN | IN2 |  |
| 4 G | GND |  |
| 5 N | NC2 |  |
| 6 C | COM2 |  |
| $7{ }^{7}$ | IN1 |  |
| 8 V | $\mathrm{V}_{\mathrm{CC}}$ |  |
| FUNCTION TABLE |  |  |
| On/Off Enable Input | Analog Switch 1 | Analog Switch 2 |
| L | Off | On |
| H | On | Off |

ORDERING INFORMATION
See detailed ordering and shipping information in the package dimensions section on page 9 of this data sheet.

## NLAS325

MAXIMUM RATINGS

| Symbol | Parameter | Value | Unit |
| :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {CC }}$ | DC Supply Voltage | -0.5 to +7.0 | V |
| $\mathrm{V}_{1}$ | DC Input Voltage | -0.5 to +7.0 | V |
| $\mathrm{V}_{\mathrm{O}}$ | DC Output Voltage | -0.5 to +7.0 | V |
| $\mathrm{I}_{\mathrm{IK}}$ | DC Input Diode Current $\quad \mathrm{V}_{1}<$ GND | -50 | mA |
| lok | DC Output Diode Current $\quad \mathrm{V}_{\mathrm{O}}<$ GND | -50 | mA |
| ${ }^{\circ} \mathrm{O}$ | DC Output Sink Current | $\pm 50$ | mA |
| $\mathrm{I}_{\mathrm{CC}}$ | DC Supply Current per Supply Pin | $\pm 100$ | mA |
| IGND | DC Ground Current per Ground Pin | $\pm 100$ | mA |
| $\mathrm{T}_{\text {STG }}$ | Storage Temperature Range | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{L}}$ | Lead Temperature, 1.0 mm from Case for 10 Seconds | 260 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{J}$ | Junction Temperature under Bias | + 150 | ${ }^{\circ} \mathrm{C}$ |
| $\theta_{\text {JA }}$ | Thermal Resistance (Note 1) | 250 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\mathrm{P}_{\mathrm{D}}$ | Power Dissipation in Still Air at $85^{\circ} \mathrm{C}$ | 250 | mW |
| MSL | Moisture Sensitivity | Level 1 |  |
| $\mathrm{F}_{\mathrm{R}}$ | Flammability Rating Oxygen Index: 28 to 34 | UL 94 V-0 @ 0.125 in |  |
| $\mathrm{V}_{\mathrm{ESD}}$ | ESD Withstand Voltage Human Body Model (Note 2) <br> Machine Model (Note 3)  <br> Charged Device Model (Note 4)  | $\begin{gathered} >2000 \\ >200 \\ \text { N/A } \end{gathered}$ | V |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Measured with minimum pad spacing on an FR4 board, using 10 mm -by-1 inch, 2-ounce copper trace with no air flow.
2. Tested to EIA/JESD22-A114-A.
3. Tested to EIA/JESD22-A115-A.
4. Tested to JESD22-C101-A.

## RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter |  | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {CC }}$ | DC Supply Voltage |  | 2.0 | 5.5 | V |
| $\mathrm{V}_{\text {IN }}$ | Digital Select Input Voltage |  | GND | 5.5 | V |
| $\mathrm{V}_{\text {IS }}$ | Analog Input Voltage (NC, NO, COM) |  | GND | $\mathrm{V}_{\mathrm{CC}}$ | V |
| $\mathrm{T}_{\mathrm{A}}$ | Operating Temperature Range |  | -55 | + 125 | ${ }^{\circ} \mathrm{C}$ |
| $t_{\text {f }}, t_{f}$ | Input Rise or Fall Time, SELECT | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V} \pm 0.3 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CC}}=5.0 \mathrm{~V} \pm 0.5 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 0 \\ & 0 \end{aligned}$ | $\begin{aligned} & 100 \\ & 20 \end{aligned}$ | ns/V |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

DEVICE JUNCTION TEMPERATURE VERSUS
TIME TO $0.1 \%$ BOND FAILURES
TIME TO 0.1\% BOND FAILURES

| Junction <br> Temperature ${ }^{\circ} \mathbf{C}$ | Time, Hours | Time, Years |
| :---: | :---: | :---: |
| 80 | $1,032,200$ | 117.8 |
| 90 | 419,300 | 47.9 |
| 100 | 178,700 | 20.4 |
| 110 | 79,600 | 9.4 |
| 120 | 37,000 | 4.2 |
| 130 | 17,800 | 2.0 |
| 140 | 8,900 | 1.0 |



Figure 2. Failure Rate vs. Time Junction Temperature

DC CHARACTERISTICS - Digital Section (Voltages Referenced to GND)

| Symbol | Parameter | Condition | $\mathrm{V}_{\mathrm{cc}}$ | Guaranteed Limit |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | $-55^{\circ} \mathrm{C}$ to $25^{\circ} \mathrm{C}$ | $<85^{\circ} \mathrm{C}$ | $<125^{\circ} \mathrm{C}$ |  |
| $\mathrm{V}_{\mathrm{IH}}$ | Minimum High-Level Input Voltage, Select Inputs |  | 2.0 | 1.5 | 1.5 | 1.5 | V |
|  |  |  | 2.5 | 1.9 | 1.9 | 1.9 |  |
|  |  |  | 3.0 | 2.1 | 2.1 | 2.1 |  |
|  |  |  | 4.5 | 3.15 | 3.15 | 3.15 |  |
|  |  |  | 5.5 | 3.85 | 3.85 | 3.85 |  |
| $\mathrm{V}_{\text {IL }}$ | Maximum Low-Level Input Voltage, Select Inputs |  | 2.0 | 0.5 | 0.5 | 0.5 | V |
|  |  |  | 2.5 | 0.6 | 0.6 | 0.6 |  |
|  |  |  | 3.0 | 0.9 | 0.9 | 0.9 |  |
|  |  |  | 4.5 | 1.35 | 1.35 | 1.35 |  |
|  |  |  | 5.5 | 1.65 | 1.65 | 1.65 |  |
| IN | Maximum Input Leakage Current, Select Inputs | $\mathrm{V}_{\mathrm{IN}}=5.5 \mathrm{~V}$ or GND | 0 V to 5.5 V | $\pm 0.2$ | $\pm 2.0$ | $\pm 2.0$ | $\mu \mathrm{A}$ |
| $I_{\text {cc }}$ | Maximum Quiescent Supply Current | Select and $\mathrm{V}_{\text {IS }}=\mathrm{V}_{\text {CC }}$ or GND | 5.5 | 4.0 | 4.0 | 8.0 | $\mu \mathrm{A}$ |

## DC ELECTRICAL CHARACTERISTICS - Analog Section

| Symbol | Parameter | Condition | $\mathrm{V}_{\mathrm{cc}}$ | Guaranteed Limit |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | $-55^{\circ} \mathrm{C}$ to $25^{\circ} \mathrm{C}$ | $<85^{\circ} \mathrm{C}$ | $<125^{\circ} \mathrm{C}$ |  |
| RON | Maximum "ON" Resistance (Figures 16-22) | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{IL}} \text { or } \mathrm{V}_{\mathrm{IH}} \\ & \mathrm{~V}_{\mathrm{IS}}=\mathrm{GND} \text { to } \mathrm{V}_{\mathrm{CC}} \\ & \mathrm{I}_{\mathrm{IN}} \leq 10 \mathrm{~mA} \end{aligned}$ | $\begin{aligned} & \hline 2.5 \\ & 3.0 \\ & 4.5 \\ & 5.5 \end{aligned}$ | $\begin{aligned} & 85 \\ & 45 \\ & 30 \\ & 25 \end{aligned}$ | $\begin{aligned} & 95 \\ & 50 \\ & 35 \\ & 30 \end{aligned}$ | $\begin{gathered} 105 \\ 55 \\ 40 \\ 35 \end{gathered}$ | $\Omega$ |
| RFLAT(ON) | ON Resistance Flatness (Figures 16 - 22) | $\begin{aligned} & \mathrm{V}_{\text {IN }}=\mathrm{V}_{\mathrm{IL}} \text { or } \mathrm{V}_{\mathrm{IH}} \\ & \mathrm{I}_{\text {IN }} \leq 10 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{IS}}=1.0 \mathrm{~V}, 2.0 \mathrm{~V}, 3.5 \mathrm{~V} \end{aligned}$ | 4.5 | 4.0 | 4.0 | 5.0 | $\Omega$ |
| InC(OFF) $I_{\text {NO(OFF) }}$ | NO or NC Off Leakage Current (Figure 8) | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{IL}} \text { or } \mathrm{V}_{\mathrm{IH}} \\ & \mathrm{~V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=1.0 \mathrm{~V}_{\mathrm{COM}} 4.5 \mathrm{~V} \end{aligned}$ | 5.5 | 1.0 | 10 | 100 | nA |
| $\mathrm{I}_{\text {COM (ON) }}$ | COM ON Leakage Current (Figure 8) | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{IL}} \text { or } \mathrm{V}_{\mathrm{IH}}$ <br> $\mathrm{V}_{\mathrm{NO}} 1.0 \mathrm{~V}$ or 4.5 V with $\mathrm{V}_{\mathrm{NC}}$ floating or <br> $\mathrm{V}_{\mathrm{NO}} 1.0 \mathrm{~V}$ or 4.5 V with $\mathrm{V}_{\mathrm{NO}}$ floating <br> $\mathrm{V}_{\text {COM }}=1.0 \mathrm{~V}$ or 4.5 V | 5.5 | 1.0 | 10 | 100 | nA |

AC ELECTRICAL CHARACTERISTICS (Input $\mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=3.0 \mathrm{~ns}$ )

| Symbol | Parameter | Test Conditions | $\mathrm{V}_{\mathrm{Cc}}$ <br> (V) | $\mathrm{V}_{\text {IS }}$ <br> (V) | Guaranteed Maximum Limit |  |  |  |  |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | $-55^{\circ} \mathrm{C}$ to $25^{\circ} \mathrm{C}$ |  |  | $<85^{\circ} \mathrm{C}$ |  | $<125^{\circ} \mathrm{C}$ |  |  |
|  |  |  |  |  | Min | Typ* | Max | Min | Max | Min | Max |  |
| ton | Turn-On Time (Figures 11 and 12) | $\mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$ <br> (Figures 4 and 5) | 2.5 | 2.0 | 5.0 | 23 | 35 | 5.0 | 38 | 5.0 | 41 | ns |
|  |  |  | 3.0 | 2.0 | 5.0 | 16 | 24 | 5.0 | 27 | 5.0 | 30 |  |
|  |  |  | 4.5 | 3.0 | 2.0 | 11 | 16 | 2.0 | 19 | 2.0 | 22 |  |
|  |  |  | 5.5 | 3.0 | 2.0 | 9.0 | 14 | 2.0 | 17 | 2.0 | 20 |  |
| toff | Turn-Off Time (Figures 11 and 12) | $\mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$ <br> (Figures 4 and 5) | 2.5 | 2.0 | 1.0 | 7.0 | 12 | 1.0 | 15 | 1.0 | 18 | ns |
|  |  |  | 3.0 | 2.0 | 1.0 | 5.0 | 10 | 1.0 | 13 | 1.0 | 16 |  |
|  |  |  | 4.5 | 3.0 | 1.0 | 4.0 | 6.0 | 1.0 | 9.0 | 1.0 | 12 |  |
|  |  |  | 5.5 | 3.0 | 1.0 | 3.0 | 5.0 | 1.0 | 8.0 | 1.0 | 11 |  |
| $\mathrm{t}_{\text {BBM }}$ | Minimum Break-Before-Make Time | $\begin{aligned} & \mathrm{V}_{\mathrm{IS}}=3.0 \mathrm{~V}(\text { Figure } 3) \\ & \mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} \end{aligned}$ | 2.5 | 2.0 | 1.0 | 12 |  | 1.0 |  | 1.0 |  | ns |
|  |  |  | 3.0 | 2.0 | 1.0 | 11 |  | 1.0 |  | 1.0 |  |  |
|  |  |  | 4.5 | 3.0 | 1.0 | 6.0 |  | 1.0 |  | 1.0 |  |  |
|  |  |  | 5.5 | 3.0 | 1.0 | 5.0 |  | 1.0 |  | 1.0 |  |  |

${ }^{*}$ Typical Characteristics are at $25^{\circ} \mathrm{C}$.

|  |  | Typical @ 25, $\mathbf{V}_{\mathrm{CC}}=5.0 \mathrm{~V}$ |  |
| :--- | :--- | :---: | :---: |
|  | Maximum Input Capacitance, Select Input | 8.0 | pF |
| $\mathrm{C}_{\mathrm{IN}}$ | 10 |  |  |
| $\mathrm{C}_{\mathrm{NO}}$ or $\mathrm{C}_{\mathrm{NC}}$ | Analog I/O (switch off) | 10 |  |
| $\mathrm{C}_{\mathrm{COM}}$ | Common I/O (switch off) | 20 |  |
| $\mathrm{C}_{(\mathrm{ON})}$ | Feedthrough (switch on) | 20 |  |

ADDITIONAL APPLICATION CHARACTERISTICS (Voltages Referenced to GND Unless Noted)

| Symbol | Parameter | Condition | $\mathrm{V}_{\mathrm{cc}}$ <br> (V) | Typical | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | $25^{\circ} \mathrm{C}$ |  |
| BW | Maximum On-Channel -3.0 dB Bandwidth or Minimum Frequency Response (Figure 10) | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{dBm}$ <br> $\mathrm{V}_{\text {IN }}$ centered between $\mathrm{V}_{\mathrm{CC}}$ and GND <br> (Figure 6) | $\begin{aligned} & \hline 3.0 \\ & 4.5 \\ & 5.5 \end{aligned}$ | $\begin{aligned} & 145 \\ & 170 \\ & 175 \end{aligned}$ | MHz |
| $\mathrm{V}_{\text {ONL }}$ | Maximum Feedthrough On Loss | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{dBm} @ 100 \mathrm{kHz}$ to 50 MHz <br> $\mathrm{V}_{\mathrm{IN}}$ centered between $\mathrm{V}_{\mathrm{CC}}$ and GND <br> (Figure 6) | $\begin{aligned} & \hline 3.0 \\ & 4.5 \\ & 5.5 \end{aligned}$ | $\begin{aligned} & \hline-2.0 \\ & -2.0 \\ & -2.0 \end{aligned}$ | dB |
| VISO | Off-Channel Isolation (Figure 9) | $\mathrm{f}=100 \mathrm{kHz} ; \mathrm{V}_{\text {IS }}=1.0 \mathrm{~V}$ RMS <br> $\mathrm{V}_{\mathrm{IN}}$ centered between $\mathrm{V}_{\mathrm{CC}}$ and $G N D$ <br> (Figure 6) | $\begin{aligned} & \hline 3.0 \\ & 4.5 \\ & 5.5 \\ & \hline \end{aligned}$ | $\begin{aligned} & -93 \\ & -93 \\ & -93 \end{aligned}$ | dB |
| Q | Charge Injection Select Input to Common I/O (Figure 14) | $\begin{aligned} & V_{I N}=V_{C C} \text { to } G N D, F_{I S}=20 \mathrm{kHz} \\ & \mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=3.0 \mathrm{~ns} \\ & \mathrm{R}_{I S}=0 \Omega, C_{\mathrm{L}}=1000 \mathrm{pF} \\ & \mathrm{Q}=\mathrm{C}_{\mathrm{L}}{ }^{*} \Delta \mathrm{~V}_{\text {OUT }} \end{aligned}$ <br> (Figure 7) | $\begin{aligned} & 3.0 \\ & 5.5 \end{aligned}$ | $\begin{aligned} & 1.5 \\ & 3.0 \end{aligned}$ | pC |
| THD | Total Harmonic Distortion THD + Noise (Figure 13) | $\begin{aligned} & \mathrm{F}_{\text {IS }}=20 \mathrm{~Hz} \text { to } 100 \mathrm{kHz}, \mathrm{R}_{\mathrm{L}}=\text { Rgen }=600 \Omega, \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF} \\ & \mathrm{~V}_{\mathrm{IS}}=5.0 \mathrm{~V}_{\mathrm{PP}} \text { sine wave } \end{aligned}$ | 5.5 | 0.1 | \% |
| VCT | Channel-to-Channel Crosstalk | $\begin{aligned} & \hline \mathrm{f}=100 \mathrm{kHz} ; \mathrm{V}_{\text {IS }}=1.0 \mathrm{~V} \text { RMS } \\ & \mathrm{V}_{\text {IN }} \text { centered between } \mathrm{V}_{\mathrm{CC}} \text { and } \mathrm{GND} \\ & \text { (Figure 6) } \\ & \hline \end{aligned}$ | $\begin{aligned} & 5.5 \\ & 3.0 \end{aligned}$ | $\begin{aligned} & -90 \\ & -90 \end{aligned}$ | dB |

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Figure 3. $\mathrm{t}_{\mathrm{BB}}$ (Time Break-Before-Make)


Figure 4. $\mathrm{t}_{\mathrm{ON}} / \mathrm{t}_{\mathrm{OFF}}$


Figure 5. ton/toff

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Channel switch control/s test socket is normalized. Off isolation is measured across an off channel. On loss is the bandwidth of an On switch. $\mathrm{V}_{\text {ISO }}$, Bandwidth and $\mathrm{V}_{\text {ONL }}$ are independent of the input signal direction.
$\mathrm{V}_{\text {ISO }}=$ Off Channel Isolation $=20 \log \left(\frac{\mathrm{~V}_{\text {OUT }}}{\mathrm{V}_{\text {IN }}}\right)$ or $\mathrm{V}_{\text {IN }}$ at 100 kHz
$V_{\text {ONL }}=$ On Channel Loss $=20 \log \left(\frac{V_{\text {OUT }}}{V_{\text {IN }}}\right)$ for $V_{\text {IN }}$ at 100 kHz to 50 MHz
Bandwidth (BW) = the frequency 3.0 dB below $\mathrm{V}_{\mathrm{ONL}}$
$\mathrm{V}_{\mathrm{CT}}=$ Use $\mathrm{V}_{\text {ISO }}$ setup and test to all other switch analog input/outputs terminated with $50 \Omega$
Figure 6. Off Channel Isolation/On Channel Loss (BW)/Crosstalk (On Channel to Off Channel)/VONL


Figure 7. Charge Injection: (Q)


Figure 8. Switch Leakage vs. Temperature


Figure 9. Off-Channel Isolation


Figure 11. $\mathrm{t}_{\mathrm{ON}}$ and $\mathrm{t}_{\mathrm{OFF}} \mathrm{vs} . \mathrm{V}_{\mathrm{CC}}$ at $25^{\circ} \mathrm{C}$


Figure 13. Total Harmonic Distortion Plus Noise vs. Frequency


Figure 10. Typical Bandwidth and Phase Shift


Figure 12. $t_{\text {ON }}$ and toff $^{\text {vs. Temp }}$


Figure 14. Charge Injection vs. COM Voltage


Figure 15. $\mathrm{I}_{\mathrm{Cc}}$ vs. Temp, $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$ and 5.0 V


Figure 17. $\mathrm{R}_{\mathrm{ON}} \mathrm{vs}$ Temp, $\mathrm{V}_{\mathrm{Cc}}=2.0 \mathrm{~V}$


Figure 19. Row vs. Temp, $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$


Figure 16. $\mathrm{R}_{\mathrm{ON}}$ vs. $\mathrm{V}_{\mathrm{CC}}, \mathrm{Temp}=25^{\circ} \mathrm{C}$


Figure 18. $\mathrm{R}_{\mathrm{ON}}$ vs. Temp, $\mathrm{V}_{\mathrm{CC}}=2.5 \mathrm{~V}$


Figure 20. $\mathrm{R}_{\mathrm{ON}} \mathrm{vs}$. Temp, $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$

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Figure 21. $\mathrm{R}_{\mathrm{ON}}$ vs. Temp, $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}$


Figure 22. R $_{\mathrm{ON}}$ vs. $\mathrm{Temp}^{\mathrm{V}} \mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$

ORDERING INFORMATION

| Device <br> Order Number | Package Type | Tape and <br> Reel Shippingize $\dagger$ |
| :---: | :---: | :---: |
| NLAS325USG | US8 | $3000 /$ Tape \& Reel |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

SCALE $4: 1$

strategy and soldertio detalls, pleaze
dominoad the ON Senconductor soldering and
Mounting Techniques Reference Manual,
Moonnoad the ON Senticoncuctor Soldering an
MOUNERRNHD.
NDTES:

1. DIMENSIONING AND TQLERANCING PER ANSI Y14.5M, 1982.
2. CINTRILLING DIMENSİN: MILLIMETERS
3. Dimensian a daes nat include mald flash, pratrusidn, aR GAte burr. mald flash, pratrusion, ar gate burr SHALL NOT EXCEED 0.14 ( $0.0055^{\circ}$ ) PER SIDE.
4. Dimensian b daes nat include interlead flash ar pratrusicn. interlead flash and pratrusinn shall nat EXCEED 0.14 ( $0.0055^{\circ}$ ) PER SIDE.
5. LEAD FINISH IS SOLDER PLATING WITH THICKNESS DF $0.0076-0.0203$ MM ( $0.003-0.008^{\circ}$ ).
6. ALL TOLERANCE UNLESS $\quad$ aTHERWISE SPECIFIED $\pm 0.0508$ MM ( $0.000^{\circ}$ ).

| DIM | MILLIMETERS |  | INCHES |  |
| :---: | :---: | :---: | :---: | :---: |
|  | MIN. | MAX. | MIN | MAX. |
| A | 1.90 | 2.10 | 0.075 | 0.083 |
| B | 2.20 | 2.40 | 0.087 | 0.094 |
| C | 0.60 | 0.90 | 0.024 | 0.035 |
| D | 0.17 | 0.25 | 0.007 | 0.010 |
| F | 0.20 | 0.35 | 0.008 | 0.014 |
| G | 0.50 BSC |  | 0.020 BSC |  |
| H | 0.40 REF |  | 0.016 REF |  |
| J | 0.10 | 0.18 | 0.004 | 0.007 |
| K | 0.00 | 0.10 | 0.000 | 0.004 |
| L | 3.00 | 3.25 | 0.118 | 0.128 |
| M | $0{ }^{\circ}$ | $6^{\circ}$ | $0^{\circ}$ | $6^{\circ}$ |
| N | $0 \times$ | $10^{\circ}$ | $0^{\circ}$ | $10^{\circ}$ |
| P | 0.23 | 0.34 | 0.010 | 0.013 |
| R | 0.23 | 0.33 | 0.009 | 0.013 |
| S | 0.37 | 0.47 | 0.015 | 0.019 |
| U | 0.60 | 0.80 | 0.024 | 0.031 |
| V | 0.12 BSC |  | 0.005 BSC |  |

GENERIC MARKING DIAGRAM*


| XX | $=$ Specific Device Code |
| :--- | :--- |
| M | $=$ Date Code |
| - | $=$ Pb-Free Package |

(Note: Microdot may be in either location)
*This information is generic. Please refer to device data sheet for actual part marking. $\mathrm{Pb}-F r e e$ indicator, " G " or microdot " r ", may or may not be present. Some products may not follow the Generic Marking.

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